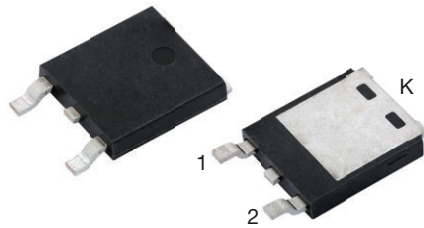
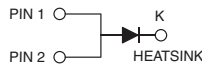


High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

 Ultra Low $V_F = 0.27\text{ V}$ at $I_F = 5\text{ A}$
TMBS® eSMP® Series

SlimDPAK


FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: SlimDPAK

 Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant
 Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	35 A
V_{RRM}	45 V
I_{FSM}	260 A
V_F at $I_F = 35\text{ A}$ ($T_A = 125\text{ °C}$)	0.46 V
T_J max.	150 °C
Package	SlimDPAK
Diode variation	Single die

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)

PARAMETER	SYMBOL	V35PW45	UNIT
Device marking code		V35PW45	
Maximum repetitive peak reverse voltage	V_{RRM}	45	V
Maximum average forward rectified current (Fig. 1)	$I_{F(AV)}^{(1)}$	35	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	260	A
Operating junction and storage temperature range	T_J, T_{STG}	-40 to +150	°C

Note
⁽¹⁾ With infinite heat sink



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum Instantaneous forward voltage	I _F = 5.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.40	-	V
	I _F = 17.5 A			0.47	-	
	I _F = 35 A			0.54	0.62	
	I _F = 5.0 A	T _A = 125 °C		0.27	-	
	I _F = 17.5 A			0.37	-	
	I _F = 35 A			0.46	0.54	
Reverse current	V _R = 45 V	T _A = 25 °C	I _R ⁽²⁾	-	2.5	mA
		T _A = 125 °C		27	65	
Typical junction capacitance	4.0 V, 1 MHz		C _J	4230	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)			
PARAMETER	SYMBOL	V35PW45	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾⁽²⁾	55	°C/W
	R _{θJM} ⁽³⁾	1.5	

Notes

- (1) The heat generated must be less than thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{θJA}
(2) Free air, mounted on recommended copper pad area; thermal resistance R_{θJA} - junction to ambient
(3) Mounted on infinite heat sink; thermal resistance R_{θJM} - junction-to-mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V35PW45-M3/I	0.20	I	4500	13" diameter plastic tape and reel
V35PW45HM3/I ⁽¹⁾	0.20	I	4500	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

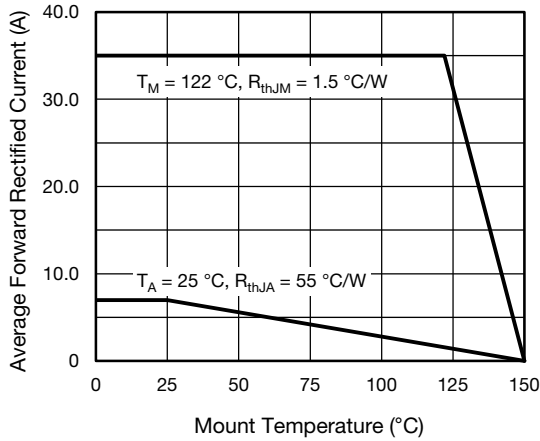


Fig. 1 - Maximum Forward Current Derating Curve

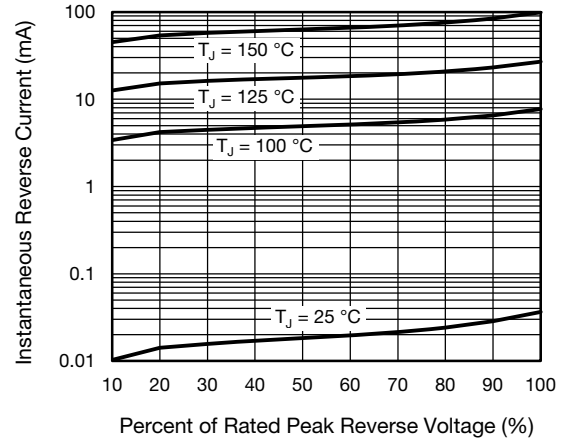


Fig. 4 - Typical Reverse Leakage Characteristics

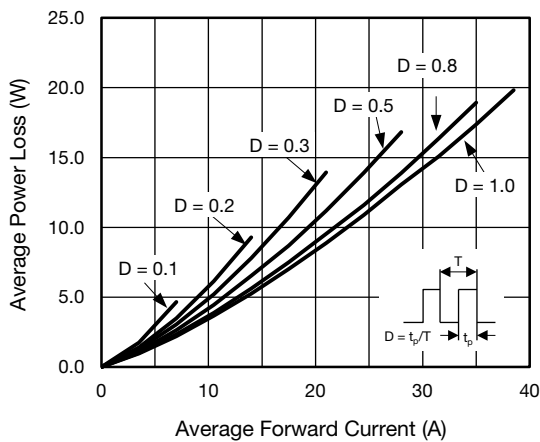


Fig. 2 - Forward Power Loss Characteristics

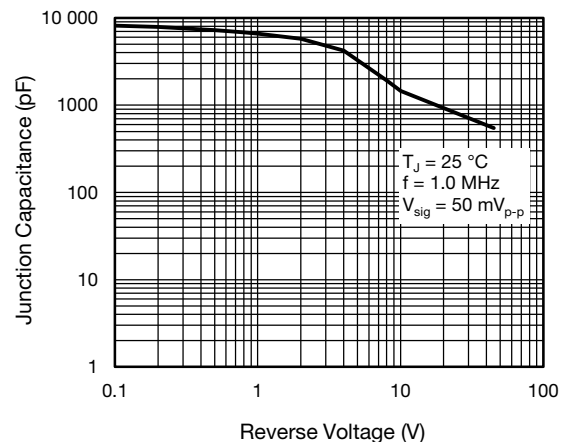


Fig. 5 - Typical Junction Capacitance

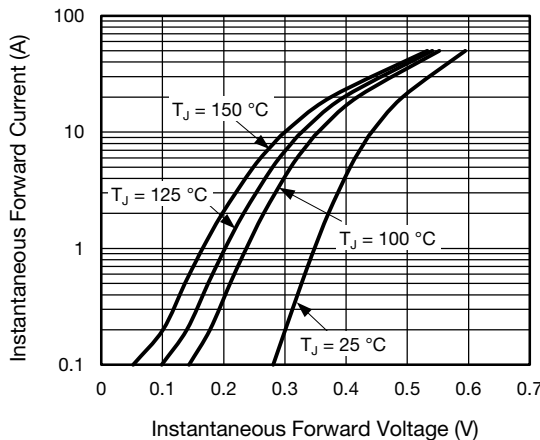


Fig. 3 - Typical Instantaneous Forward Characteristics

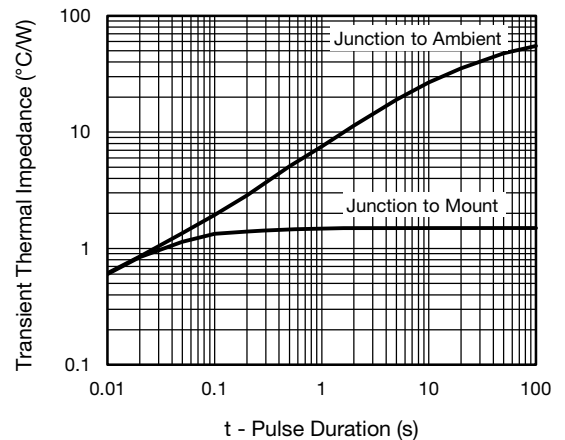


Fig. 6 - Typical Transient Thermal Impedance

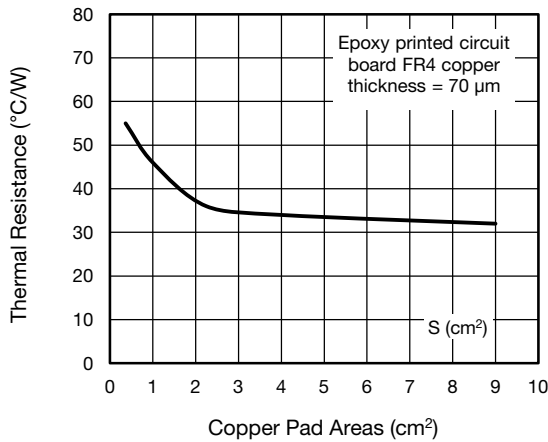
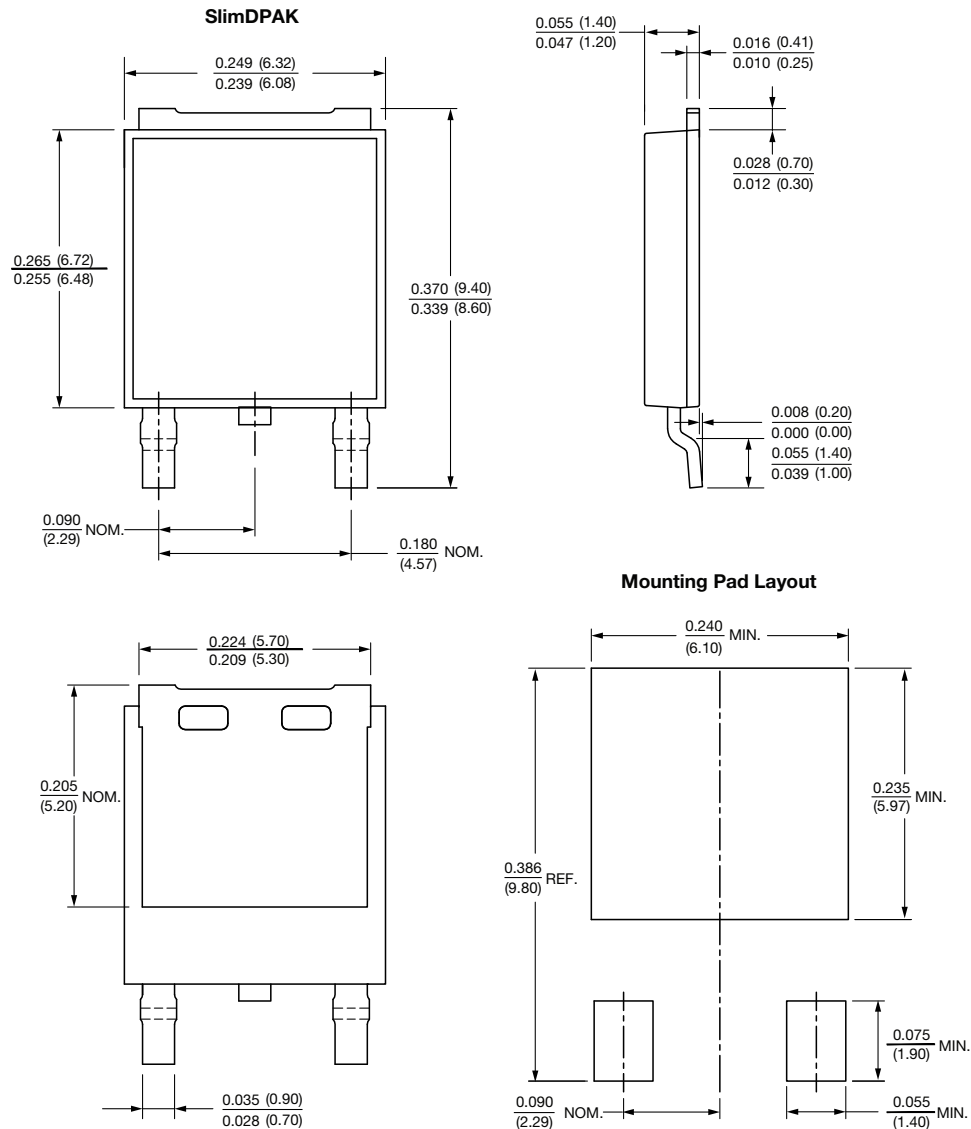


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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